

L Number	Hits	Search Text	DB	Time stamp
7	99	reticle adj layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 09:24
8	0	(test or testing) and US-6028336-A.DID.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 09:24
-	2	("5940704").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 14:14
-	0	5940704.URPN.	USPAT	2002/12/31 13:04
-	1821	second and transistor and reference adj voltage and measuring and testing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:06
-	37	measuring adj current near drain	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:29
-	0	reticle adj option adj layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/04/16 09:22
-	37196	wafer and test	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:32
-	17233	reticle	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:15
-	1638	(wafer and test) and reticle	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:16
-	13608	(probe or probing) and die	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:16
-	123	((wafer and test) and reticle) and ((probe or probing) and die)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:17
-	990341	pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:17
-	5333	test adj voltage	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 14:20

	0	((wafer and test) and reticle) and ((probe or probing) and die)) and pin) and (test adj voltage)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:18
	57	((wafer and test) and reticle) and ((probe or probing) and die)) and pin	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:28
	7514	"burn-in"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:28
	1997	(wafer and test) and "burn-in"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 14:23
	695	((probe or probing) and die) and ((wafer and test) and "burn-in")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:28
	462	pin and (((probe or probing) and die) and ((wafer and test) and "burn-in"))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:28
	11376	measuring adj current	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:29
	8	(pin and (((probe or probing) and die) and ((wafer and test) and "burn-in")) and (measuring adj current))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:31
	133141	reference adj voltage	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:32
	152	(wafer and test) and "burn-in" and (reference adj voltage)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:32
	153889	source and gate and drain	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:33
	88	((wafer and test) and "burn-in" and (reference adj voltage)) and (source and gate and drain)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:47
	6	(measuring adj current) and (((wafer and test) and "burn-in" and (reference adj voltage)) and (source and gate and drain))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 13:47
	2	("4758863").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/31 14:14
	18	4758863.URPN.	USPAT	2002/12/31 14:14

-	0	test adj voltage and 4758863.URPN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/12/31 14:21
-	51233	process adj control	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/12/31 14:22
-	27	(wafer and test) and "burn-in" and (process adj control)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2002/12/31 14:23
-	930	(438/14).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT	2003/01/03 13:44
-	20	("3716296" "4620785" "4748478" "4758863" "4803524" "4849313" "4869998" "5036209" "5049925" "5235626" "5298761" "5308741" "5393988" "5422491" "5434647" "5439764" "5451479" "5571643" "5699260" "5705299").PN.	USPAT	2003/10/23 10:59
-	0	6421111.URPN.	USPAT	2003/10/23 11:01